



300mA, Low Power Consumption, High Voltage CMOS LDO Regulator

1 FEATURES

- Input Voltage Range: 3 V to 45 V
- Output Voltage Range:
 Fixed Option: 1.8V, 2.5V, 3.0V, 3.3V and 5.0V
- Very low I_Q: 3µA (TYP)
- Up to 300mA Load Current
- Low Dropout Voltage
- Low Temperature Coefficient
- Current Limit Protection
- Over Temperature Protection
- Output Voltage Accuracy: ±1%
- SOT23-3, SOT23-5, SOT89-3 and SOT-223 Packages

2 APPLICATIONS

- Smart Power Network Equipment
- Portable Power Tools
- Bms Systems
- Motor Control System/Industrial Control System
- Power Meter/Instrument
- White Goods
- Vehicle-Mounted System
- Battery-Powered Equipment
- Automotive Head Unit
- Security Equipment
- Communication Equipment

3 DESCRIPTIONS

The RS3015 series is a Low Dropout Linear Regulator designed by CMOS technology. Which can provide 300 mA output current. The device allows input voltage as high as 45 V. It is very suitable for multi-cell battery systems, bus voltage power supply systems, Vehicle battery power supply system and other high DC voltage systems. Wide input voltage can make it well withstand the impact of surge voltage and ensure the stability of output voltage.

The RS3015 series only consume $3\mu A$ (typical), Which is particularly important in battery power system, can reduce the standby power consumption of the whole system.

The RS3015 is available in Green SOT23-3, SOT23-5, SOT89-3 and SOT-223 variety of packages, for the different application's requirements.

Device Information⁽¹⁾

200000000000000000000000000000000000000						
PART NUMBER	PACKAGE	BODY SIZE (NOM)				
	SOT23-3	1.60mm×2.92mm				
RS3015	SOT23-5	1.60mm×2.92mm				
K33013	SOT89-3	2.45mm×4.50mm				
	SOT-223	3.50mm×7.00mm				

(1) For all available packages, see the orderable addendum at the next page of the data sheet.

4 TYPICAL APPLICATION SCHEMATIC





5 FUNCTIONAL BLOCK DIAGRAM





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6 REVISION HISTORY

Note: Page numbers for previous revisions may different from page numbers in the current version.

VERSION	Change Date	Change Item
A.0	2024/04/17	Preliminary version completed
A.0.1	2024/08/19	 Delete ±1.5% DC Output Accuracy Update Electrical Characteristics Update Typical Characteristics Figure 15-22
A.1	2025/01/23	Update Electrical Characteristics
A.2	2025/04/27	 Update Absolute Maximum Ratings Update Electrical Characteristics Update Typical Characteristics Add SOT89-3(L-Type) Package



7 PACKAGE/ORDERING INFORMATION⁽¹⁾

PRODUCT	ORDERING NUMBER	Vout(V)	Vout Accuracy	PACKAGE LEAD	PACKAGE MARKING	MSL ⁽³⁾	PACKAGE OPTION
RS3015-1.8	RS3015-1.8XF3	1.8	±1%	SOT23-3	SF18	MSL3	Tape and Reel, 3000
	RS3015-1.8XF5	1.8	±1%	SOT23-5	SF18	MSL3	Tape and Reel, 3000
K33013-1.0	RS3015-1.8XE3	1.8	±1%	SOT89-3	SF18	MSL3	Tape and Reel, 1000
	RS3015-1.8XD3	1.8	±1%	SOT-223	SF18	MSL3	Tape and Reel, 2500
	RS3015-2.5XF3	2.5	±1%	SOT23-3	SF25	MSL3	Tape and Reel, 3000
RS3015-2.5	RS3015-2.5XF5	2.5	±1%	SOT23-5	SF25	MSL3	Tape and Reel, 3000
R33013-2.3	RS3015-2.5XE3	2.5	±1%	SOT89-3	SF25	MSL3	Tape and Reel, 1000
	RS3015-2.5XD3	2.5	±1%	SOT-223	SF25	MSL3	Tape and Reel, 2500
	RS3015-3.0XF3	3.0	±1%	SOT23-3	SF30	MSL3	Tape and Reel, 3000
RS3015-3.0	RS3015-3.0XF5	3.0	±1%	SOT23-5	SF30	MSL3	Tape and Reel, 3000
K53015-3.0	RS3015-3.0XE3	3.0	±1%	SOT89-3	SF30	MSL3	Tape and Reel, 1000
	RS3015-3.0XD3	3.0	±1%	SOT-223	SF30	MSL3	Tape and Reel, 2500
	RS3015-3.3XF3	3.3	±1%	SOT23-3	SF33	MSL3	Tape and Reel, 3000
	RS3015-3.3XF5	3.3	±1%	SOT23-5	SF33	MSL3	Tape and Reel, 3000
RS3015-3.3	RS3015-3.3XE3	3.3	±1%	SOT89-3	SF33	MSL3	Tape and Reel, 1000
	RS3015-3.3XE3L	3.3	±1%	SOT89-3 (L-Type)	SF33L	MSL3	Tape and Reel, 1000
	RS3015-3.3XD3	3.3	±1%	SOT-223	SF33	MSL3	Tape and Reel, 2500
	RS3015-5.0XF3	5.0	±1%	SOT23-3	SF50	MSL3	Tape and Reel, 3000
RS3015-5.0	RS3015-5.0XF5	5.0	±1%	SOT23-5	SF50	MSL3	Tape and Reel, 3000
	RS3015-5.0XE3	5.0	±1%	SOT89-3	SF50	MSL3	Tape and Reel, 1000
	RS3015-5.0XE3L	5.0	±1%	SOT89-3 (L-Type)	SF50L	MSL3	Tape and Reel, 1000
	RS3015-5.0XD3	5.0	±1%	SOT-223	SF50	MSL3	Tape and Reel, 2500

NOTE:

(1) This information is the most current data available for the designated devices. This data is subject to change without notice and revision of this document. For browser-based versions of this data sheet, refer to the right-hand navigation.

(2) There may be additional marking, which relates to the lot trace code information (data code and vendor code), the logo or the environmental category on the device.

(3) RUNIC classify the MSL level with using the common preconditioning setting in our assembly factory conforming to the JEDEC industrial standard J-STD-20F. Please align with RUNIC if your end application is quite critical to the preconditioning setting or if you have special requirement.



8 PIN CONFIGURATION AND FUNCTIONS (TOP VIEW)



PIN DESCRIPTION

		PIN					
NAME SOT23-3 SOT23-5		SOT89-3 SOT89-3 (L-Type) SOT-22		SOT-223	FUNCTION		
GND	1	2	2	1	2	Ground	
VOUT	2	5	1	3	3	Regulated output voltage. Connect a minimum 1µF Iow-ESR capacitor to this pin.	
VIN	3	1	3	2	1	Input voltage supply. Must be closely decoupled to GND with a 1μ F or greater capacitor.	
EN	/	3	/	/	/	Enable input. A low voltage ($< V_{IL}$) on this pin turns the regulator off. A high voltage ($> V_{IH}$) on this pin enables the regulator output. The EN pin can be connected to the VIN pin if not used. Do not leave floating.	
NC	/	4	/	/	/	No internal connection	



9 SPECIFICATIONS

9.1 Absolute Maximum Ratings

over operating free-air temperature range (unless otherwise noted) (1) (2)

			MIN	MAX	UNIT
VIN	Input voltage		-0.3	55	V
V _{EN}	V _{EN} voltage range		-0.3	VIN	V
Vout	V _{OUT} voltage range		-0.3	7	V
٦J	PN Junction temperature ⁽³⁾		-40	175	°C
PD	Continuous power dissipation ⁽⁴⁾		Internall	y limited	W
		SOT23-3		250	
	Package thermal impedance ⁽⁵⁾	SOT23-5		160	°C/W
θ」Α		SOT89-3		135	
		SOT89-3(L-Type)		78	
		SOT-223		100	
		SOT23-3		120	°C/W
		SOT23-5		95	
οlc	Junction-to-case (top) thermal resistance	SOT89-3		85	
		SOT89-3(L-Type)		43	
		SOT-223		70	
T _{stg}	Storage temperature range		-65	150	°C

Stresses beyond those listed under Absolute Maximum Ratings may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated under Recommended Operating Conditions is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.

(2) All voltages are with respect to the GND pin.

(3) The maximum power dissipation is a function of $T_{J(MAX)}$, $R_{\theta JA}$, and T_A . The maximum allowable power dissipation at any ambient temperature is $P_D = (T_{J(MAX)} - T_A) / R_{\theta JA}$. All numbers apply for packages soldered directly onto a PCB.

(4) Internal thermal shutdown circuitry protects the device from permanent damage. The actual chip output current is subject to the inputoutput voltage difference, ambient temperature and PCB heat dissipation design.

(5) The package thermal impedance is calculated in accordance with JESD-51.

9.2 ESD Ratings

The following ESD information is provided for handling of ESD-sensitive devices in an ESD protected area only.

			VALUE	UNIT	
V		Human-Body Model (HBM), MIL-STD-883K METHOD 3015.9	±2000	V	
V(ESD)	Electrostatic discharge	Charge Device Model (CDM), ANSI/ESDA/JEDEC JS-002-2022	±1000	V	



ESD SENSITIVITY CAUTION

ESD damage can range from subtle performance degradation to complete device failure. Precision integrated circuits may be more susceptible to damage because very small parametric changes could cause the device not to meet its published specifications.



9.3 Recommended Operating Conditions over operating free-air temperature range (unless otherwise noted)

		MIN	MAX	UNIT
VIN	Input Voltage Range on VIN	3	45	V
VEN	Input Voltage Range on EN	0	VIN	V
Ιουτ	Output Current Range on IOUT	0	300	mA
TA	Operating Ambient Temperature Range	-40	125	°C
٦	PN Junction temperature	-40	125	°C



9.4 Electrical Characteristics

Over operating temperature range ($-40^{\circ}C \le T_J \le 125^{\circ}C$), $V_{IN} = V_{OUT}nom + 2V^{(1)}$, $C_{IN} = C_{OUT} = 1\mu$ F, $V_{OUT}=3.3$ V, unless otherwise noted. Typical values are at $T_A = 25^{\circ}C$.

PARAMETER	SYMBOL	со	NDITIONS	MIN ⁽²⁾	TYP ⁽³⁾	MAX ⁽²⁾	UNIT
POWER SUPPLY AND CUR	RENTS						
Input Voltage ⁽¹⁾	VIN			3	12	45	V
Under Voltage Lockout	UVLO	VIN rising		2.2	2.55	2.9	V
Hysteresis	V _{HYS}	VIN falling		75	125	200	mV
Quiescent Current	lq	V _{EN} = 1.7V, Iou	T = 0mA	1	3	5	μA
Ground Pin Current		V _{EN} = 1.7V, I _{OU}	_T = 100mA	260	380	500	μA
Shutdown Current	Isd	$V_{EN} = 0V$		-1	0.1	1	μA
OUTPUT VOLTAGE						•	
Output Voltage Range	Vout			1.8		5.0	V
DC Output Accuracy ⁽¹⁾	ΔV _{OUT}	Т _Ј = 25°С, І _{ОUT}	= 1mA	-1		1	%
Line Regulation ⁽¹⁾	$\Delta V_{\text{OUT}(\Delta \text{VIN})}$	$V_{IN} = V_{OUT} + 2V_{OUT}$	/ to 45V, I _{OUT} = 1mA	-0.004	0.001	0.004	%/V
Load Regulation ⁽¹⁾	$\Delta V_{OUT(\Delta IOUT)}$	V _{IN} =V _{OUT} + 2V	, Iout = 1mA to 300mA	-40	20	40	mV
Output Voltage	ΔV_{OUT}	Iout = 1mA, TJ	= -40°C ~ 85°C	10	70	200	ppm/°C
Temperature Coefficient ⁽⁴⁾	$\Delta T_A \times V_{OUT}$	lout = 1mA, Τι	= -40°C ~ 125°C	10	70	200	ppm/°C
Maximum output current ⁽⁵⁾	Іоитмах			300			mA
DROPOUT VOLTAGE							
			V _{OUT} = 1.8V		TBD		mV
			Vout = 2.5V		TBD		
Dropout Voltage (6)	Vdo	Іоит = 300mA	V _{OUT} = 3.0V	1000	1200	1400	
			V _{OUT} = 3.3V	950	1150	1350	
			V _{OUT} = 5.0V	810	1030	1250	
POWER SUPPLY REJECTIO	N RATIO AND	NOISE					
			f = 100Hz	50	60	70	dB
			f = 217Hz	50	60	70	dB
Power Supply Rejection Ratio ⁽⁷⁾	PSRR	V _{OUT} = 3.3V, I _{OUT} = 10mA	f = 1KHz	48	58	68	dB
Katio ···		1001 - 1011A	f = 10KHz	43	53	63	dB
			f = 100KHz	35	45	55	dB
Output Noise Voltage ⁽⁷⁾	VN	BW = 10Hz ~ 1 I _{OUT} = 300mA	100KHz, V _{OUT} = 3.3V,	40	120	200	μV _{RMS}
ENABLE AND STARTUP TIM	1E						
EN Input Logic High Voltage	VIH	V _{IN} = 3V to 45V	V, EN rising	1.7	1.3	1.55	V
EN Input Logic Low Voltage	VIL	V _{IN} = 3V to 45	V, EN falling	0.55	0.7	0.4	V
EN Input lookage surrent	les :	V _{IN} = 45, V _{EN} = 0V		-0.1	0.01	0.1	μA
EN Input leakage current	len	V _{IN} = 45, V _{EN} = 45V		0.5	1.5	3	μA
PROTECTIONS							
Over Current Limit	Ilmt	$V_{IN} = 14V$, $V_{OUT} = 0.9$ * V_{OUT} nom		350	550	750	mA
Thermal shutdown threshold ⁽⁷⁾	T _{TSD}			150	165	180	°C
Thermal shutdown hysteresis ⁽⁷⁾	T _{HYS}			10	20	30	°C



NOTE:

- (1) Minimum $V_{IN} = V_{OUT} + V_{DO}$ or 3V, whichever is greater.
- (2) Limits are 100% production tested at 25°C. Limits over the operating temperature range are ensured through correlations using statistical quality control (SQC) method.
- (3) Typical values represent the most likely parametric norm as determined at the time of characterization. Actual typical values may vary over time and will also depend on the application and configuration.
- (4) Output voltage temperature coefficient is defined as the worst-case voltage change divided by the total temperature range.
- (5) Maximum output current is affected by the PCB layout, size of metal trace, the thermal conduction path between metal layers, ambient temperature and the other environment factors of system. Attention should be paid to the dropout voltage when V_{IN} < V_{OUT} + V_{DROP}.
- (6) V_{DROP} FT test method: test the V_{OUT} voltage at V_{SET} + V_{DROPMAX} with output current.
- (7) Guaranteed by design and characterization, not a FT item.





Figure 1. Quiescent Current vs Input Voltage



Figure 3. Shutdown Current vs Junction Temperature



Figure 5. Ground Pin Current vs Output Current



Figure 2. Quiescent Current vs Temperature



Figure 4. Supply Current vs Input Voltage



















Figure 29. Line Transient Response



Figure 26. Line Transient Response



Figure 28. Line Transient Response



Figure 30. Load Transient Response





Figure 31. Load Transient Response



10 DETAILED DESCRIPTION

10.1 Overview

The RS3015 series is a Low Dropout Linear Regulator designed by CMOS technology. Which can provide 300 mA output current. The device allows input voltage as high as 45 V. It is very suitable for multi-cell battery systems, bus voltage power supply systems, Vehicle battery power supply system and other high DC voltage systems. Wide input voltage can make it well withstand the impact of surge voltage and ensure the stability of output voltage.

The RS3015 series only consume $3\mu A$ (typical), Which is particularly important in battery power system, can reduce the standby power consumption of the whole system.

10.2 Under Voltage Lockout (UVLO)

The RS3015 family of devices uses an under voltage lockout circuit to keep the output shut off until the internal circuitry is operating properly.

10.3 Shutdown

Enable input. A low voltage (< V_{IL}) on this pin turns the regulator off. A high voltage (> V_{IH}) on this pin enables the regulator output. The EN pin can be connected to the VIN pin if not used. Do not leave floating.

10.4 Thermal Overload Protection (TsD)

Thermal shutdown disables the output when the junction temperature rises to approximately 165°C which allows the device to cool. When the junction temperature cools to approximately 145°C, the output circuitry enables.

Based on power dissipation, thermal resistance, and ambient temperature, the thermal protection circuit may cycle on and off. This thermal cycling limits the dissipation of the regulator and protects it from damage as a result of overheating.

The thermal shutdown circuitry of the RS3015 has been designed to protect against temporary thermal overload conditions. The T_{SD} circuitry was not intended to replace proper heat-sinking. Continuously running the RS3015 device into thermal shutdown may degrade device reliability.

10.5 Disabled

The device is disabled under the following conditions:

- The input voltage is less than the UVLO threshold minus V_{HYS}, or has not yet exceeded the UVLO threshold.
- The enable voltage is less than the enable falling threshold voltage or has not yet exceeded the enable rising threshold.
- The device junction temperature is greater than the thermal shutdown temperature.

10.6 Current-Limit Protection

The RS3015 monitors the current flowing through the output PMOS and limits the maximum current to prevent load and RS3015 from damages during current overload conditions.

10.7 Input and Output Capacitor Requirements

Connecting a 1μ F low-equivalent series resistance (ESR) capacitor across the input supply near the regulator is good analog design practice. This capacitor counteracts reactive input sources and improves transient response and ripple rejection. A higher value capacitor can be necessary if large, fast, rise-time load transients are anticipated or if the device is located several inches from the power source.

The RS3015 family of devices is designed to be stable with standard ceramic output capacitors of values 1μ F or larger. X5R- and X7R-type capacitors are best because they have minimal variation in value and ESR over temperature.



11 POWER SUPPLY RECOMMENDATIONS

The device is designed to operate from an input voltage supply range between 3V and 45V. The input voltage range must provide adequate headroom in order for the device to have a regulated output. This input supply must be well regulated. If the input supply is noisy, additional input capacitors with low ESR can help improve output noise.

12 LAYOUT

For best overall performance, place all circuit components on the same side of the circuit board and as near as practical to the respective LDO pin connections. Place ground return connections to the input and output capacitor, and to the LDO ground pin as close to each other as possible, connected by a wide, component-side, copper surface. The use of vias and long traces to create LDO component connections is strongly discouraged and negatively affects system performance. This grounding and layout scheme minimizes inductive parasitics, and thereby reduces load-current transients, minimizes noise, and increases circuit stability. A ground reference plane is also recommended and is either embedded in the printed circuit board (PCB) itself or located on the bottom side of the PCB opposite the components. This reference plane serves to assure accuracy of the output voltage, shields the LDO from noise, and behaves similar to a thermal plane to spread (or sink) heat from the LDO device when connected to the exposed thermal pad. In most applications, this ground plane is necessary to meet thermal requirements.

To improve ac performance (such as PSRR, output noise, and transient response), designing the board with separate ground planes for V_{IN} and V_{OUT} is recommended, with each ground plane connected only at the GND pin of the device. In addition, the ground connection for the bypass capacitor must connect directly to the GND pin of the device.



13 PACKAGE OUTLINE DIMENSIONS SOT23-3⁽³⁾





RECOMMENDED LAND PATTERN (Unit: mm)





Complete	Dimensions I	n Millimeters	Dimensions In Inches		
Symbol	Min	Max	Min	Мах	
A ⁽¹⁾	1.050	1.250	0.041	0.049	
A1	0.000	0.100	0.000	0.004	
A2	1.050	1.150	0.041	0.045	
b	0.300	0.500	0.012	0.020	
с	0.100	0.200	0.004	0.008	
D ⁽¹⁾	2.820	3.020	0.111	0.119	
E ⁽¹⁾	1.500	1.700	0.059	0.067	
E1	2.650	2.950	0.104	0.116	
е	0.950(BSC) ⁽²⁾	0.037(BSC) ⁽²⁾	
e1	1.800	2.000	0.071	0.079	
L	0.300	0.600	0.012	0.024	
θ	0°	8°	0°	8°	

NOTE:

1. Plastic or metal protrusions of 0.15mm maximum per side are not included.

2. BSC (Basic Spacing between Centers), "Basic" spacing is nominal.

3. This drawing is subject to change without notice.



SOT23-5⁽³⁾





RECOMMENDED LAND PATTERN (Unit: mm)





Cumhal	Dimensions I	n Millimeters	Dimensions In Inches		
Symbol	Min	Max	Min	Мах	
A ⁽¹⁾	1.050	1.250	0.041	0.049	
A1	0.000	0.100	0.000	0.004	
A2	1.050	1.150	0.041	0.045	
b	0.300	0.500	0.012	0.020	
с	0.100	0.200	0.004	0.008	
D ⁽¹⁾	2.820	3.020	0.111	0.119	
E ⁽¹⁾	1.500	1.700	0.059	0.067	
E1	2.650	2.950	0.104	0.116	
e	0.950(BSC) ⁽²⁾	0.037(BSC) ⁽²⁾	
e1	1.800	2.000	0.071	0.079	
L	0.300	0.600	0.012	0.024	
θ	0°	8°	0°	8°	

NOTE:

Plastic or metal protrusions of 0.15mm maximum per side are not included.
 BSC (Basic Spacing between Centers), "Basic" spacing is nominal.

3. This drawing is subject to change without notice.



SOT89-3⁽⁴⁾



Comb el	Dimensions I	n Millimeters	Dimensions In Inches		
Symbol	Min Max		Min	Max	
A ⁽¹⁾	1.400	1.600	0.055	0.063	
b	0.320	0.520	0.013	0.020	
b1	0.400	0.580	0.016	0.023	
с	0.350	0.440	0.014	0.017	
D ⁽¹⁾	4.400	4.600	0.173	0.181	
D1	1.550	REF ⁽²⁾	0.061 REF ⁽²⁾		
E ⁽¹⁾	2.300	2.600	0.091	0.102	
E1	3.940	4.250	0.155	0.167	
e	1.500 BSC ⁽³⁾		0.060 BSC ⁽³⁾		
e1	3.000 BSC ⁽³⁾		0.118 BSC ⁽³⁾		
L	0.900	1.200	0.035	0.047	

NOTE:

1. Plastic or metal protrusions of 0.15mm maximum per side are not included.
2. REF is the abbreviation for Reference.

- 3. BSC (Basic Spacing between Centers), "Basic" spacing is nominal.
- 4. This drawing is subject to change without notice.



SOT-223⁽³⁾



Symbol	Dimensions I	n Millimeters	Dimensions In Inches			
	Min	Min Max		Мах		
A ⁽¹⁾	-	1.800	-	0.071		
A1	0.02	0.10	0.001	0.004		
A2	1.55	1.65	0.061	0.065		
b	0.66	0.84	0.026	0.033		
b2	2.90	3.10	0.114	0.122		
D ⁽¹⁾	6.30	6.70	0.248	0.263		
E	6.70	7.30	0.263	0.287		
E1 ⁽¹⁾	3.30	3.70	0.130	0.145		
e	2.30 8	3SC ⁽²⁾	0.090 BSC ⁽²⁾			
e1	4.60 [3SC ⁽²⁾	0.181 BSC ⁽²⁾			
L	0.90	-	0.035	-		

NOTE:

Plastic or metal protrusions of 0.15mm maximum per side are not included.
 BSC (Basic Spacing between Centers), "Basic" spacing is nominal.

3. This drawing is subject to change without notice.



14 TAPE AND REEL INFORMATION REEL DIMENSIONS

REEL DIMENSIONS

TAPE DIMENSION



NOTE: The picture is only for reference. Please make the object as the standard.

KEY PARAMETER LIST OF TAPE AND REEL

Package Type	Reel Diameter	Reel Width (mm)	A0 (mm)	B0 (mm)	K0 (mm)	P0 (mm)	P1 (mm)	P2 (mm)	W (mm)	Pin1 Quadrant
SOT23-3	7"	9.0	3.20	3.30	1.30	4.0	4.0	2.0	8.0	Q3
SOT23-5	7"	9.5	3.20	3.20	1.40	4.0	4.0	2.0	8.0	Q3
SOT89-3	7"	13.2	4.85	4.45	1.85	4.0	8.0	2.0	12.0	Q3
SOT-223	13"	12.4	6.765	7.335	1.88	4.0	8.0	2.0	12.0	Q3

NOTE:

1. All dimensions are nominal.

2. Plastic or metal protrusions of 0.15mm maximum per side are not included.



IMPORTANT NOTICE AND DISCLAIMER

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